Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

N-Channel Power MOSFET

60V, 3A, 85mΩ

FEATURES

- Low $R_{DS(ON)}$ to minimize conductive losses
- Logic level
- Low gate charge for fast power switching
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

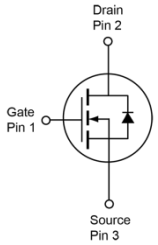
APPLICATIONS

- BLDC Motor Control
- Battery Power Management
- LED backlight

KEY PERFORMANCE PARAMETERS			
PARAMETER		**VALUE**	**UNIT**
V_{DS}		60	V
$R_{DS(on)}$ (max)	V_{GS} = 10V	85	mΩ
	V_{GS} = 4.5V	100	
Q_g		4.6	nC

Pb-Free RoHS COMPLIANT HALOGEN FREE

SOT-23



Note: MSL 3 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (Note 1)	T_C = 25°C	I_D	3	A
	T_A = 25°C		2.3	
Pulsed Drain Current		I_{DM}	12	A
Total Power Dissipation	T_C = 25°C	P_D	1.7	W
	T_C = 125°C		0.3	
Total Power Dissipation	T_A = 25°C	P_D	1	W
	T_A = 125°C		0.2	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +150	°C

THERMAL PERFORMANCE			
PARAMETER	**SYMBOL**	**LIMIT**	**UNIT**
Junction to Case Thermal Resistance	$R_{\Theta JC}$	75	°C/W
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	124	°C/W

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design.

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN**	**TYP**	**MAX**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	BV_{DSS}	60	--	--	V
Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	$V_{GS(TH)}$	1.2	1.8	2.5	V
Gate-Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	I_{GSS}	--	--	±100	nA
Drain-Source Leakage Current	V_{GS} = 0V, V_{DS} = 60V	I_{DSS}	--	--	1	μA
	V_{GS} = 0V, V_{DS} = 60V T_J = 125°C		--	--	100	
Drain-Source On-State Resistance (Note 2)	V_{GS} = 10V, I_D = 2.3A	$R_{DS(on)}$	--	68	85	mΩ
	V_{GS} = 4.5V, I_D = 2.3A		--	80	100	
Forward Transconductance (Note 2)	V_{DS} = 5V, I_D = 2.3A	g_{fs}	--	6.7	--	S
Dynamic (Note 3)						
Total Gate Charge	V_{GS} = 10V, V_{DS} = 30V, I_D = 2.3A	Q_g	--	9.5	--	nC
Total Gate Charge	V_{GS} = 4.5V, V_{DS} = 30V, I_D = 2.3A	Q_g	--	4.6	--	
Gate-Source Charge		Q_{gs}	--	1.9	--	
Gate-Drain Charge		Q_{gd}	--	1.6	--	
Input Capacitance	V_{GS} = 0V, V_{DS} = 30V f = 1.0MHz	C_{iss}	--	529	--	pF
Output Capacitance		C_{oss}	--	29	--	
Reverse Transfer Capacitance		C_{rss}	--	3	--	
Gate Resistance	f = 1.0MHz, open drain	R_g	--	1.5	--	Ω
Switching (Note 3)						
Turn-On Delay Time	V_{GS} = 10V, V_{DS} = 30V, I_D = 2.3A, R_G = 2Ω	$t_{d(on)}$	--	4.8	--	ns
Turn-On Rise Time		t_r	--	20	--	
Turn-Off Delay Time		$t_{d(off)}$	--	9.8	--	
Turn-Off Fall Time		t_f	--	17	--	
Source-Drain Diode						
Forward Voltage (Note 2)	V_{GS} = 0V, I_S = 2.3A	V_{SD}	--	--	1	V
Reverse Recovery Time	I_S = 2.3A, dI/dt = 100A/μs	t_{rr}	--	12	--	ns
Reverse Recovery Charge		Q_{rr}	--	8	--	nC

Notes:

1. Silicon limited current only.
2. Pulse test: Pulse Width ≤ 300μs, duty cycle ≤ 2%.
3. Switching time is essentially independent of operating temperature.

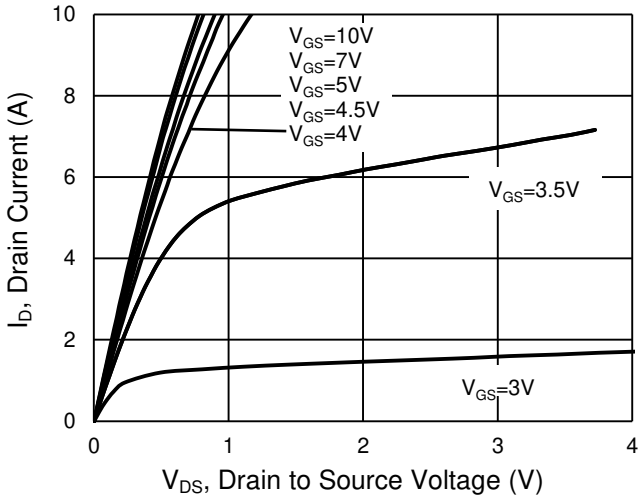
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM850N06CX RFG	SOT-23	3,000pcs / 7" Reel

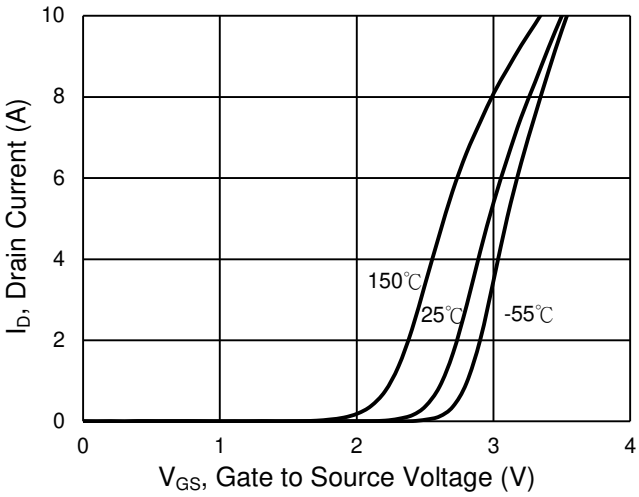
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

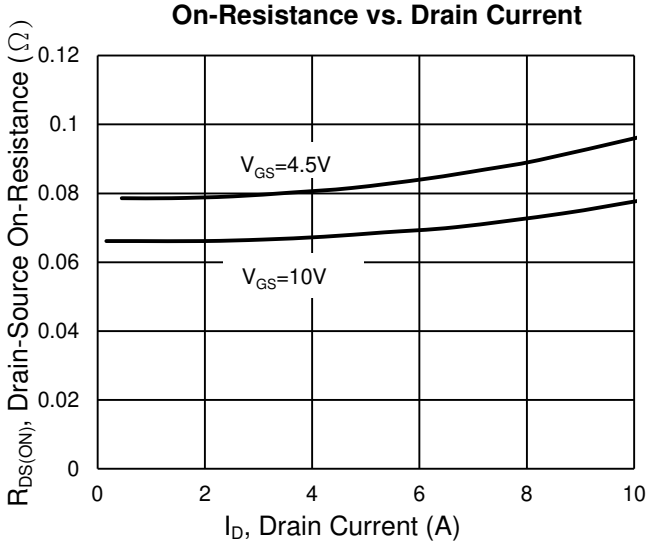
Output Characteristics



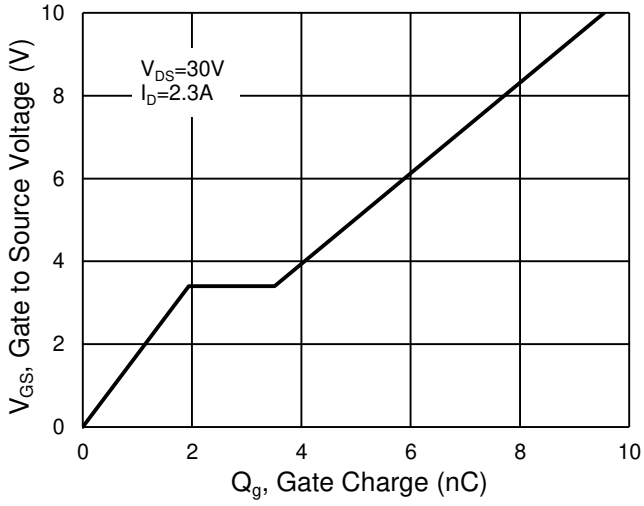
Transfer Characteristics



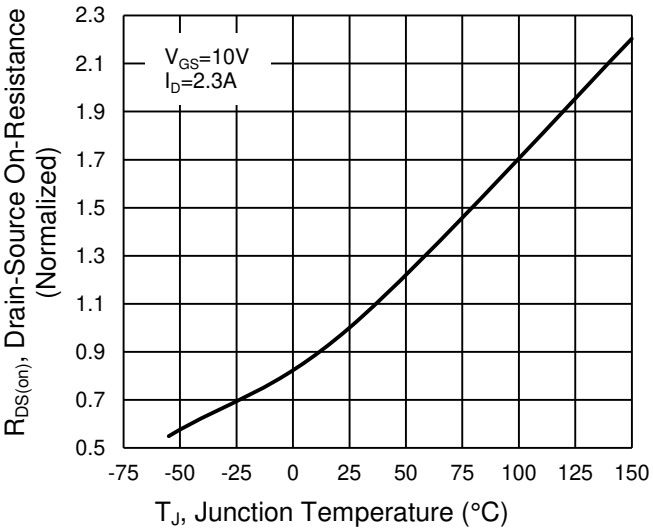
On-Resistance vs. Drain Current



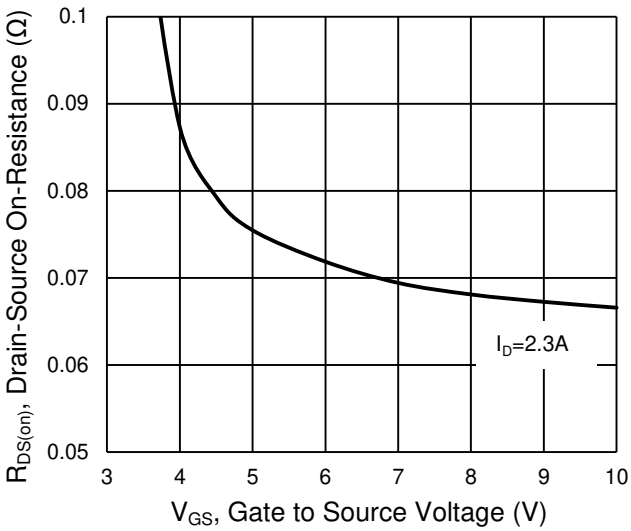
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature



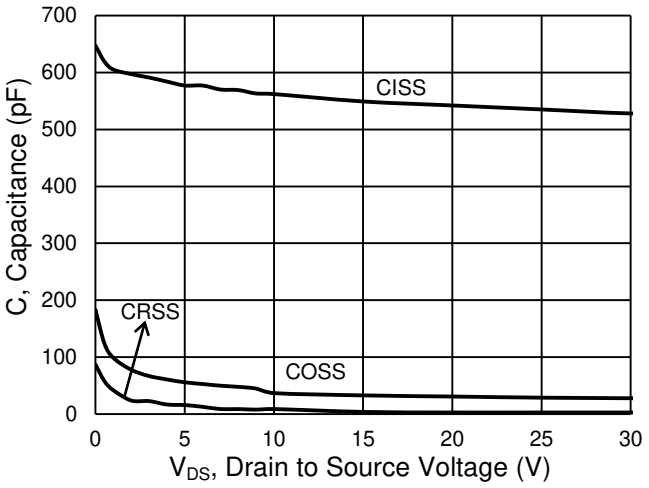
On-Resistance vs. Gate-Source Voltage



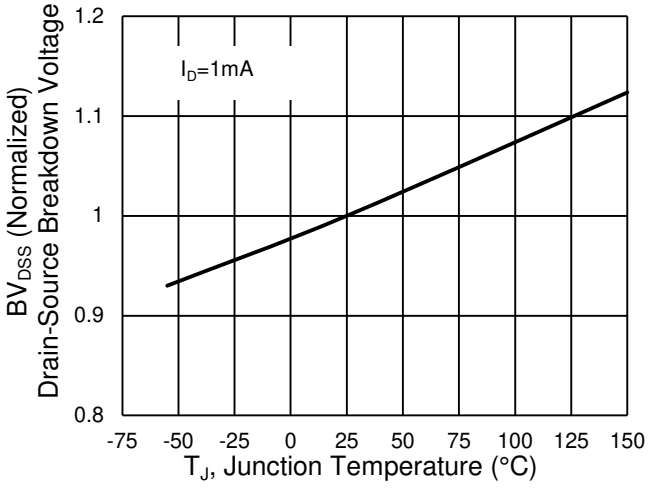
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

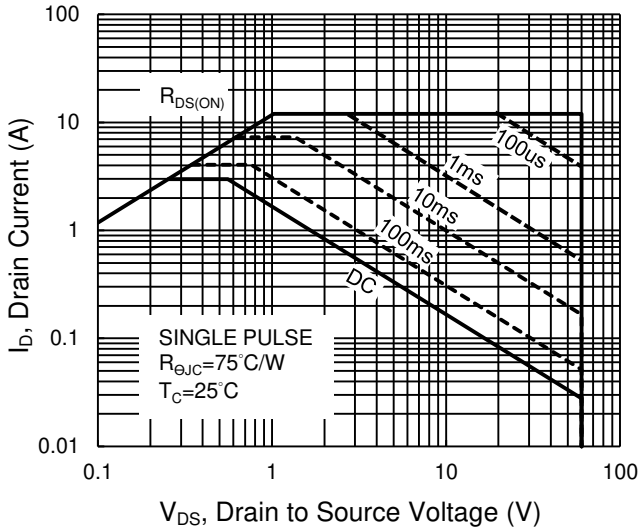
Capacitance vs. Drain-Source Voltage



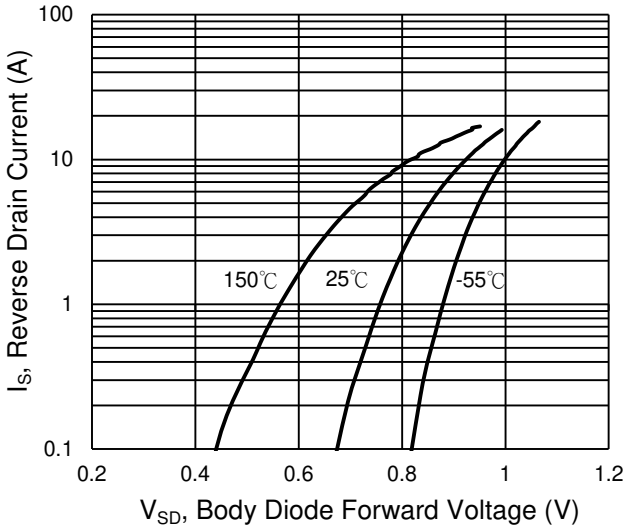
BV_{DSS} vs. Junction Temperature



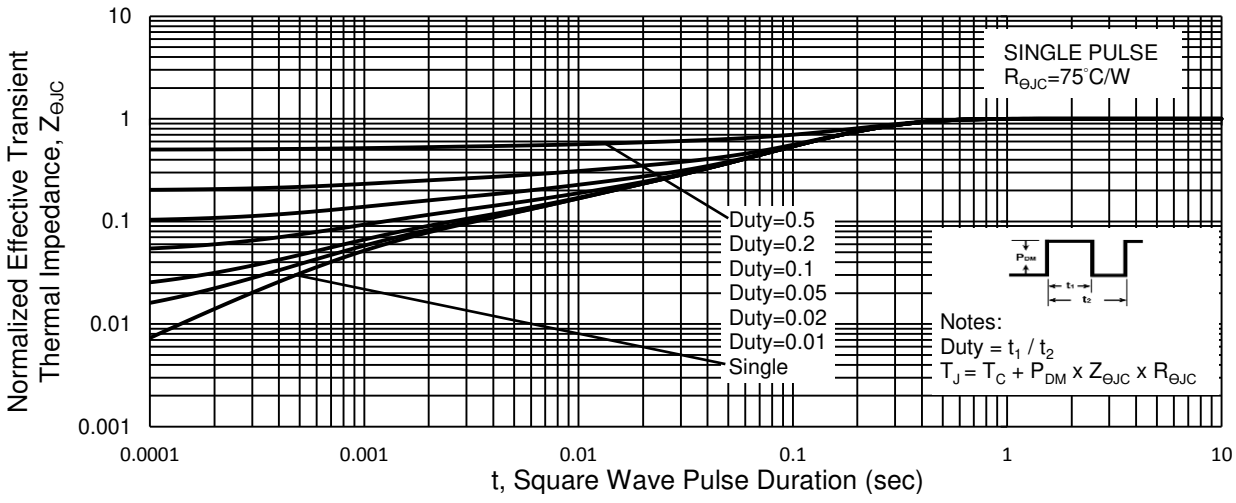
Maximum Safe Operating Area, Junction-to-Case



Source-Drain Diode Forward Current vs. Voltage

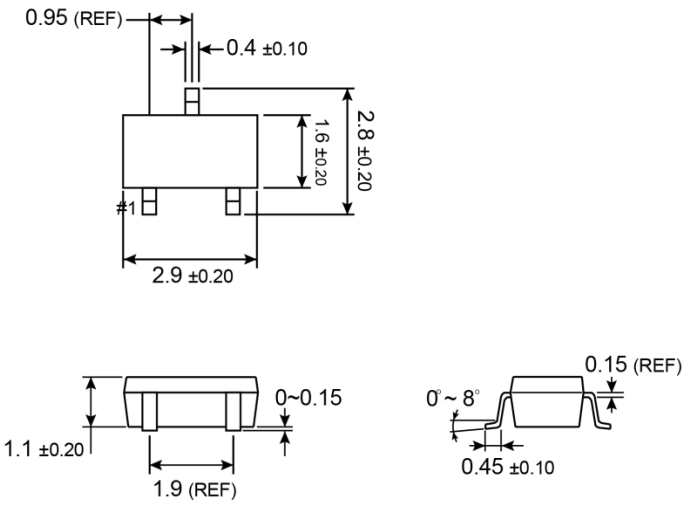


Normalized Thermal Transient Impedance, Junction-to-Case

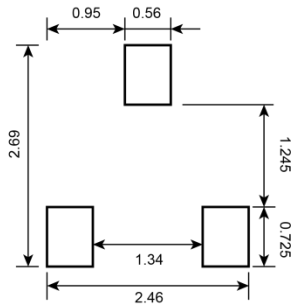


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

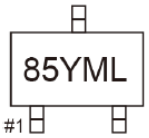
SOT-23



SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



85 = Device Code
Y = Year Code
M = Month Code

O	=Jan	**P**	=Feb	**Q**	=Mar	**R**	=Apr
S	=May	**T**	=Jun	**U**	=Jul	**V**	=Aug
W	=Sep	**X**	=Oct	**Y**	=Nov	**Z**	=Dec

L = Lot Code

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.